

2N2955 (GERMANIUM)

2N2956

2N2957



CASE 22
(TO-18)

PNP germanium epitaxial mesa transistors for high-speed switching applications.

Collector connected to case

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector-Base Voltage	V_{CB}	40	Vdc
Emitter-Base Voltage	V_{EB}	3.5	Vdc
Collector-Emitter Voltage 2N2955 2N2956 2N2957	V_{CEO}	25 20 18	Vdc
Collector Current	I_C	100	mAdc
Junction Temperature	T_J	100	$^\circ\text{C}$
Storage Temperature	T_{stg}	-65 to +100	$^\circ\text{C}$
Total Device Dissipation at 25 $^\circ\text{C}$ Case Temperature (Derate 4 mW/ $^\circ\text{C}$ above 25 $^\circ\text{C}$)	P_D	300	mW
Total Device Dissipation at 25 $^\circ\text{C}$ Ambient Temperature (Derate 2 mW/ $^\circ\text{C}$ above 25 $^\circ\text{C}$)	P_D	150	mW

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Fig. No.	Symbol	Min	Typ	Max	Unit
Collector-Base Breakdown Voltage ($I_C = 100 \mu\text{Adc}$, $I_E = 0$)		BV_{CBO}	40	60	---	Vdc
Emitter-Base Breakdown Voltage ($I_E = 100 \mu\text{Adc}$, $I_C = 0$)		BV_{EBO}	3.5	5.0	---	Vdc
Collector-Emitter Breakdown Voltage ($I_C = 10 \text{ mAdc}$, Emitter-Base Termination - Open) 2N2955 2N2956 2N2957	8	BV_{CEO}	25 20 18	35 28 25	---	Vdc
Collector-Emitter Reverse Current ($V_{CE} = 25 \text{ Vdc}$, $V_{EB} = 0.5 \text{ Vdc}$)		I_{CEX}	---	---	10	μAdc
Base Leakage Current ($V_{CE} = 25 \text{ Vdc}$, $V_{EB} = 0.5 \text{ Vdc}$)	9	I_{BL}	---	---	10	μAdc

2N2955, 2N2956, 2N2957 (Continued)

ELECTRICAL CHARACTERISTICS (continued)

Characteristic	Fig. No.	Symbol	Min	Typ	Max	Unit		
On Characteristics								
Forward Current Transfer Ratio ($I_C = 10$ mAdc, $V_{CE} = 1$ Vdc) ($I_C = 50$ mAdc, $V_{CE} = 1$ Vdc) ($I_C = 100$ mAdc, $V_{CE} = 1$ Vdc)	2N2955	1	h_{FE}	20	43	---	---	
	2N2956	2		30	64	---		
	2N2957	3		60	105	---		
	2N2955			20	43	60		
	2N2956			40	76	120		
	2N2957			100	130	---		
	2N2956			30	69	---		
	2N2957			60	115	---		
	Collector-Emitter Saturation Voltage ($I_C = 10$ mAdc, $I_B = 1$ mAdc) ($I_C = 50$ mAdc, $I_B = 5$ mAdc) ($I_C = 100$ mAdc, $I_B = 10$ mAdc)	2N2955	5	$V_{CE(sat)}$	---	0.12		0.20
2N2956		6	---		0.12	0.18		
2N2957		7	---		0.09	0.15		
2N2955				---	0.20	0.30		
2N2956				---	0.16	0.25		
2N2957				---	0.13	0.20		
2N2956				---	0.23	0.34		
2N2957				---	0.18	0.26		
Base-Emitter Voltage ($I_C = 10$ mAdc, $I_B = 1$ mAdc) ($I_C = 50$ mAdc, $I_B = 5$ mAdc) ($I_C = 100$ mAdc, $I_B = 10$ mAdc)		2N2955	4	V_{BE}	---	0.38	0.50	Vdc
	2N2956		---		0.37	0.47		
	2N2957		---		0.36	0.44		
	2N2955			---	0.51	0.65		
	2N2956			---	0.48	0.60		
	2N2957			---	0.45	0.55		
	2N2956			---	0.56	0.70		
	2N2957			---	0.52	0.65		
	Transient Characteristics							
Output Capacitance ($V_{CB} = 5$ Vdc, $I_E = 0$, $f = 1$ MHz)	10	C_{ob}	---	2.5	4.0	pF		
Input Capacitance ($V_{BE} = 1$ Vdc, $I_C = 0$, $f = 1$ MHz)	10	C_{ib}	---	3.3	---	pF		
Small Signal Forward Current Transfer Ratio ($V_{CE} = 5$ Vdc, $I_C = 10$ mAdc, $f = 100$ MHz)	2N2955 2N2956 2N2957		$ h_{fe} $	2.0 2.5 3.0	3.5 3.75 4.0	---	---	
Delay Time ($V_{CC} = 12$ Vdc, $I_{CS} = 50$ mAdc, $I_{B1} = 5$ mAdc, $V_{BE}(\text{Off}) = 2.2$ Vdc)	12	t_d	---	7.0	15	ns		
Rise Time (same conditions as t_d)	2N2955 2N2956 2N2957	12, 13	t_r	---	25 18 15	40 30 25	ns	
Storage Time ($V_{CC} = 12$ Vdc, $I_{CS} = 50$ mAdc, $I_{B1} = 5$ mAdc, $I_{B2} = 5$ mAdc)	2N2955 2N2956 2N2957	12, 16	t_s	---	28 37 42	40 55 60	ns	
Fall Time (same conditions as t_s)	2N2955 2N2956 2N2957	12, 15	t_f	---	25 18 18	40 35 35	ns	
Total Control Charge ($I_C = 10$ mAdc, $I_B = 1$ mAdc)	2N2955 2N2956 2N2957	17	Q_T	---	84 88 88	---	pc	
Active Region Time Constant ($I_C = 10$ mAdc)	14	τ_A	---	2.9	---	ns		

2N2955, 2N2956, 2N2957 (Continued)

FIGURE 1 — CURRENT GAIN CHARACTERISTICS

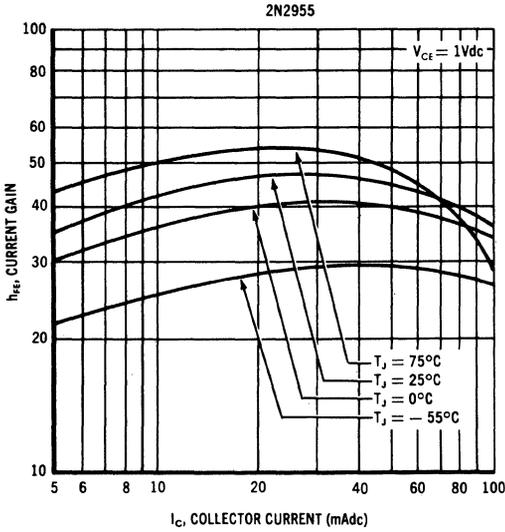


FIGURE 2 — CURRENT GAIN CHARACTERISTICS

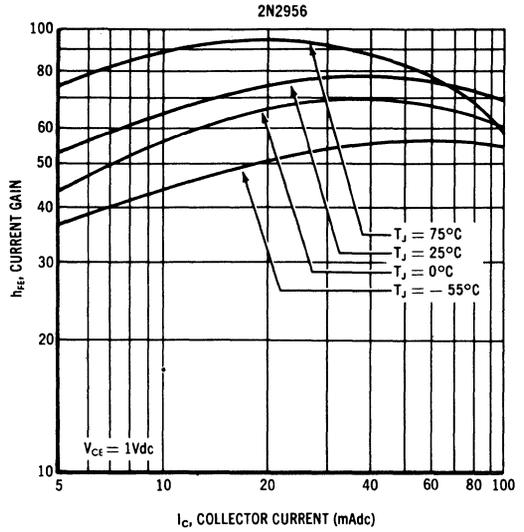


FIGURE 3 — CURRENT GAIN CHARACTERISTICS

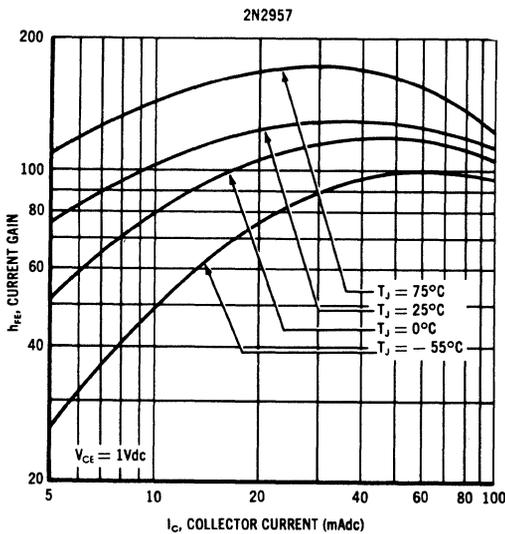
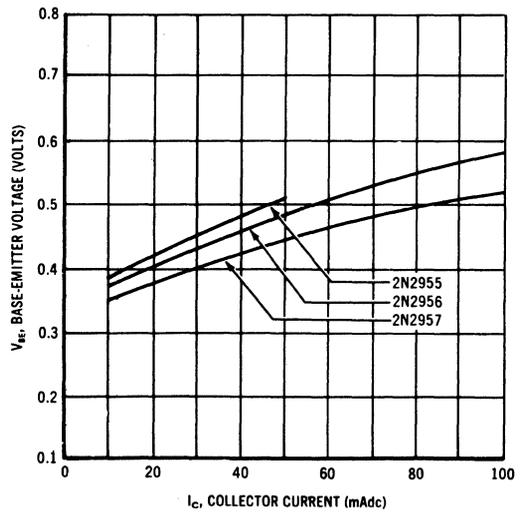


FIGURE 4 — BASE-EMITTER VOLTAGE versus COLLECTOR CURRENT



2N2955, 2N2956, 2N2957 (Continued)

COLLECTOR-EMITTER SATURATION VOLTAGE versus BASE CURRENT

FIGURE 5 — 2N2955

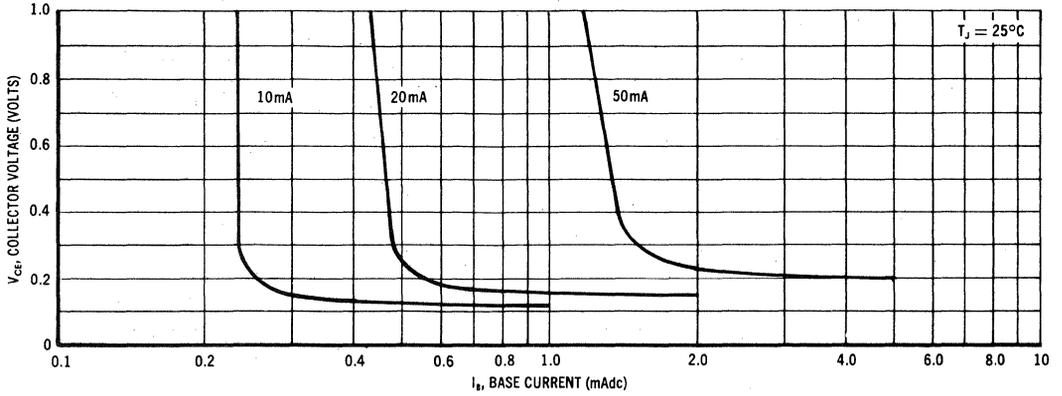


FIGURE 6 — 2N2956

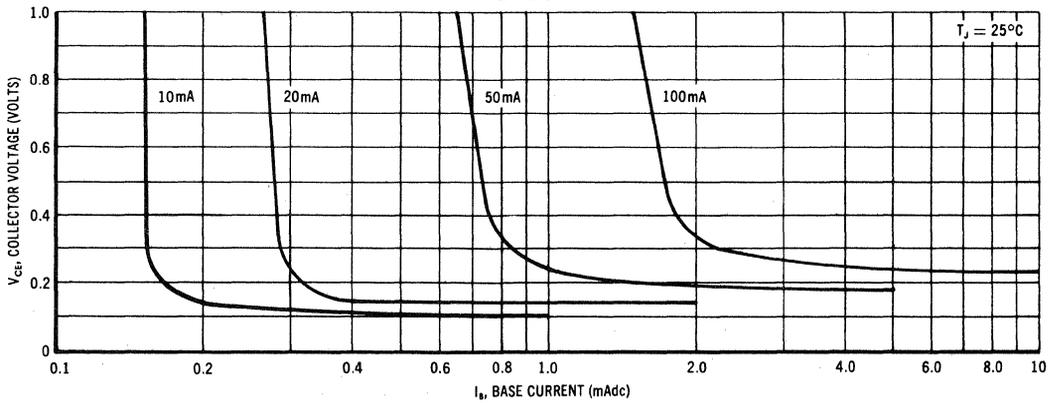
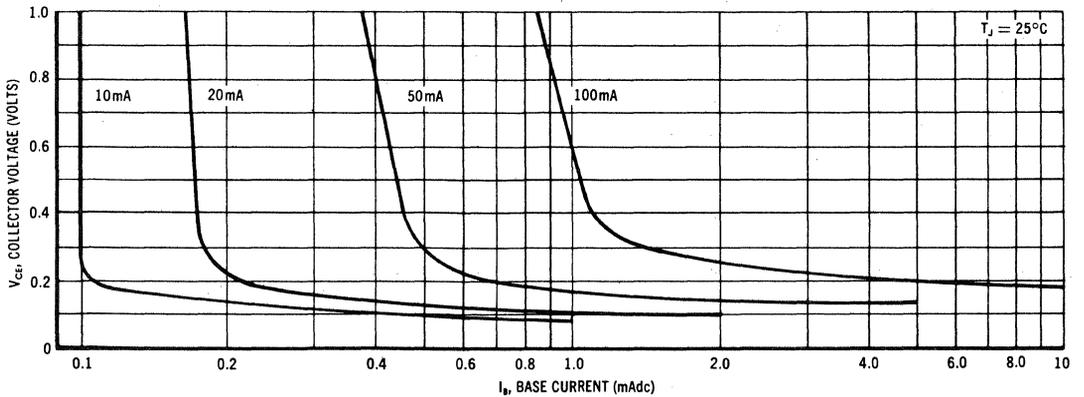


FIGURE 7 — 2N2957



2N2955, 2N2956, 2N2957 (Continued)

FIGURE 8 — OPEN BASE LOAD LINE RATING & TEST CIRCUIT

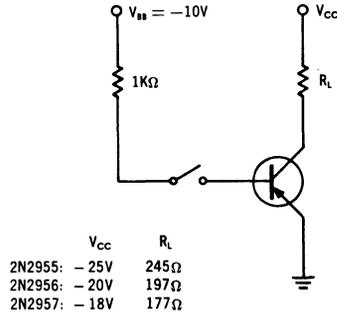
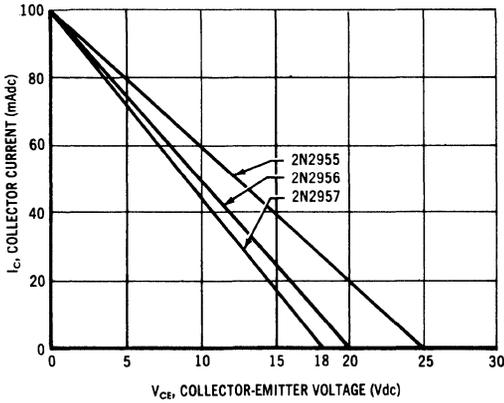
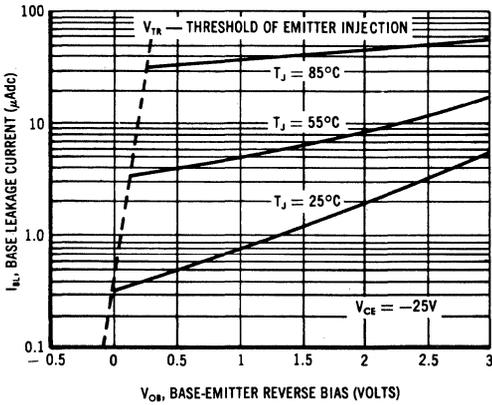
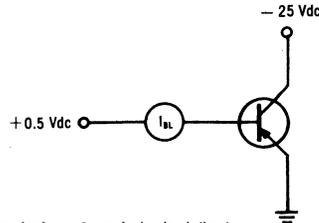


FIGURE 9 — COMMON EMITTER DC LEAKAGE CHARACTERISTICS



BASE LEAKAGE CURRENT TEST CIRCUIT



Base Leakage Current. I_{BL} is defined as base leakage current with both junctions reverse biased. I_C is always less than I_{BL} for $V_{OB} > V_{TE}$. (V_{OB} is off condition base bias, V_{TE} is base voltage at threshold of condition.)

FIGURE 10 — JUNCTION CAPACITANCE versus REVERSE BIAS

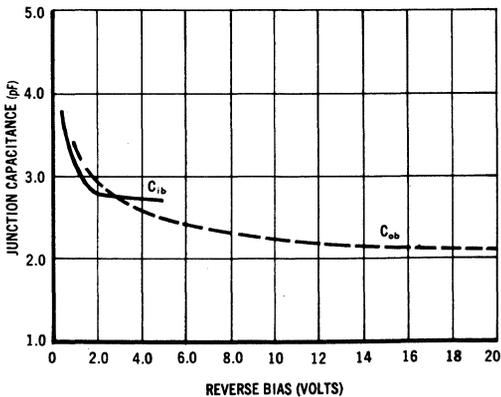
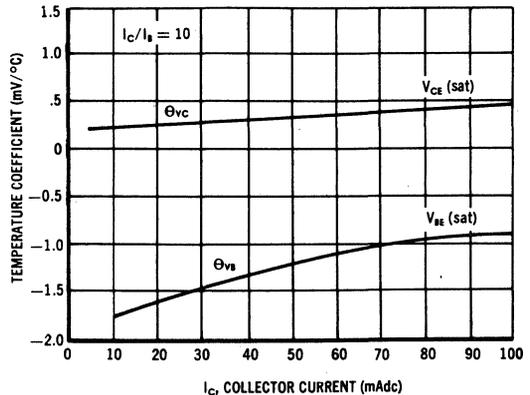


FIGURE 11 — TEMPERATURE COEFFICIENTS



2N2955, 2N2956, 2N2957 (Continued)

FIGURE 12 — SWITCHING TIME TEST CIRCUIT

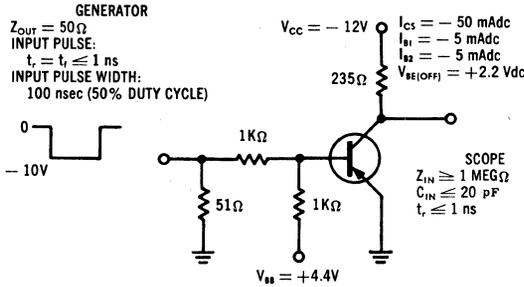


FIGURE 13 — RISE TIME FACTOR

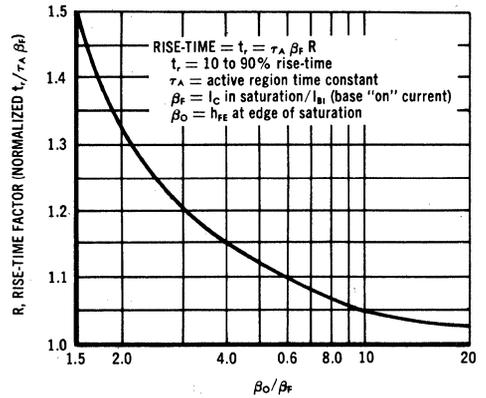


FIGURE 14 — ACTIVE REGION TIME CONSTANT

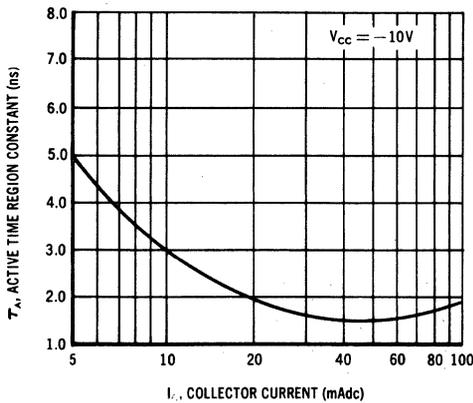


FIGURE 15 — FALL TIME FACTOR

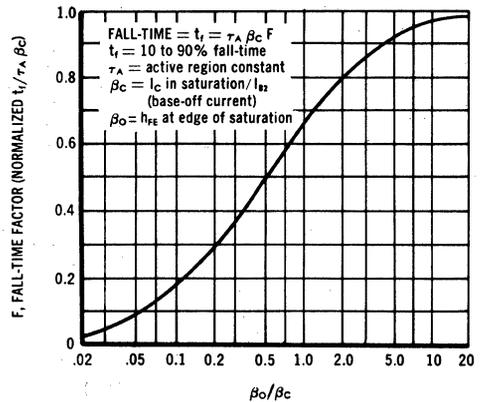


FIGURE 16 — STORAGE TIME

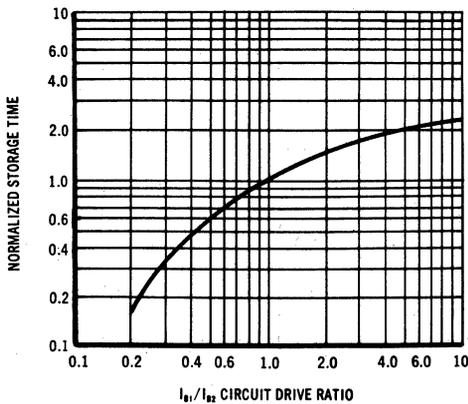


FIGURE 17 — TOTAL CONTROL CHARGE

